# International

# AUIRGR4045D AUIRGU4045D

# INSULATED GATE BIPOLAR TRANSISTOR WITH ULTRAFAST SOFT RECOVERY DIODE

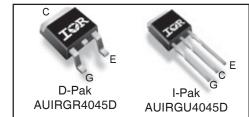
## Features

- Low  $V_{CE (on)}$  Trench IGBT Technology
- Low Switching Losses
- Maximum Junction temperature 175 °C
- 5µs SCSOA
- Square RBSOA
- 100% of the parts tested for  $I_{LM}$
- Positive V<sub>CE (on)</sub> Temperature Coefficient.
- Ultra Fast Soft Recovery Co-pak Diode
- Tighter Distribution of Parameters
- Lead-Free, RoHS Compliant
- Automotive Qualified\*

## **Benefits**

- · High Efficiency in a Wide Range of Applications
- Suitable for a Wide Range of Switching Frequencies due to Low V<sub>CE (ON)</sub> and Low Switching Losses
- Rugged Transient Performance for Increased Reliability
- Excellent Current Sharing in Parallel Operation
- Low EMI

# $V_{CES} = 600V$ $I_C = 6.0A, T_C = 100^{\circ}C$ $V_{CE(on) typ.} = 1.7V$



G	С	E
Gate	Colletor	Emitter

## **Absolute Maximum Ratings**

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature ( $T_a$ ) is 25°C, unless otherwise specified.

	Parameter	Max.	Units
V <sub>CES</sub>	Collector-to-Emitter Breakdown Voltage	600	V
I <sub>C</sub> @ T <sub>C</sub> = 25°C	Continuous Collector Current	12	
I <sub>C</sub> @ T <sub>C</sub> = 100°C	Continuous Collector Current	6.0	
I <sub>CM</sub>	Pulsed Collector Current, V <sub>GE</sub> = 15V	18	
I <sub>LM</sub>	Clamped Inductive Load Current, V <sub>GE</sub> = 20V ①	24	А
I <sub>F</sub> @T <sub>C</sub> =25°C	Diode Continuous Forward Current	8.0	
I <sub>F</sub> @T <sub>C</sub> =100°C	Diode Continuous Forward Current	4.0	
FM Diode Maximum Forward Current ©		24	
Continuous Gate-to-Emitter Voltage		± 20	V
V <sub>GE</sub>	Transient Gate-to-Emitter Voltage	± 30	
P <sub>D</sub> @ T <sub>C</sub> =25°	Maximum Power Dissipation	77	W
P <sub>D</sub> @ T <sub>C</sub> =100°	Maximum Power Dissipation	39	
TJ     Operating Junction and       TSTG     Storage Temperature Range		-55 to + 175	°C
		-55 10 + 175	
	Soldering Temperature, for 10 seconds	300 (0.063 in. (1.6mm) from c	ase)

#### **Thermal Resistance**

	Parameter	Min.	Тур.	Max.	Units
R <sub>eJC</sub>	Junction-to-Case - IGBT ③			1.9	
R <sub>eJC</sub>	Junction-to-Case - Diode ③			6.8	°C/W
R <sub>eJA</sub>	Junction-to-Ambient (PCB Mount)			50	C/ VV
$R_{ ext{ heta}JA}$	Junction-to-Ambient			110	

\*Qualification standards can be found at http://www.irf.com/

## Electrical Characteristics @ $T_J = 25^{\circ}C$ (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions	Ref.Fig
V <sub>(BR)CES</sub>	Collector-to-Emitter Breakdown Voltage	600	_	_	V	$V_{GE} = 0V, I_c = 100 \ \mu A^{\textcircled{3}}$	CT6
$\Delta V_{(BR)CES} / \Delta T_J$	Temperature Coeff. of Breakdown Voltage	_	0.36		V/°C	$V_{GE}$ = 0V, $I_{c}$ = 250 $\mu$ A ( 25 -175 $^{\circ}$ C ) ④	010
			1.7	2.0		$I_{C} = 6.0A, V_{GE} = 15V, T_{J} = 25^{\circ}C$	
V <sub>CE(on)</sub>	Collector-to-Emitter Saturation Voltage	L –	2.07	_	V	$I_{C} = 6.0A, V_{GE} = 15V, T_{J} = 150^{\circ}C$	5,6,7,9,
		_	2.14	_		I <sub>C</sub> = 6.0A, V <sub>GE</sub> = 15V, Τ <sub>J</sub> = 175°C	10 ,11
V <sub>GE(th)</sub>	Gate Threshold Voltage	3.5	—	6.5	V	$V_{CE} = V_{GE}, I_C = 150 \mu A$	9,10,11,12
$\Delta V_{GE(th)} / \Delta T J$	Threshold Voltage temp. coefficient	_	-13	_	mV/°C	$V_{CE} = V_{GE}, I_{C} = 250 \mu A (25 - 175 °C)$	9,10,11,12
gfe	Forward Transconductance	_	5.8	_	S	V <sub>CE</sub> = 25V, I <sub>C</sub> = 6.0A, PW =80µs	
I <sub>CES</sub>	Collector-to-Emitter Leakage Current	_	—	25	μA	$V_{GE} = 0V, V_{CE} = 600V$	
		_	_	250		$V_{GE} = 0V, V_{CE} = 600V, T_J = 175^{\circ}C$	8
V <sub>FM</sub>	Diode Forward Voltage Drop	—	1.60	2.30	V	I <sub>F</sub> = 6.0A	
	Diode Forward Voltage Drop	_	1.30	_		I <sub>F</sub> = 6.0A, T <sub>J</sub> = 175°C	
I <sub>GES</sub>	Gate-to-Emitter Leakage Current	_		±100	nA	$V_{GE} = \pm 20 V$	

## Switching Characteristics @ $T_J = 25^{\circ}C$ (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions	Ref.Fig
Qg	Total Gate Charge (turn-on)	_	13	19.5		I <sub>C</sub> = 6.0A	24
Q <sub>ge</sub>	Gate-to-Emitter Charge (turn-on)	_	3.1	4.65	nC	$V_{CC} = 400V$	CT1
Q <sub>gc</sub>	Gate-to-Collector Charge (turn-on)	—	6.4	9.6	1	V <sub>GE</sub> = 15V	
Eon	Turn-On Switching Loss	_	56	86		$I_{C} = 6.0A, V_{CC} = 400V, V_{GE} = 15V$	
E <sub>off</sub>	Turn-Off Switching Loss	_	122	143	μJ	$R_G = 47\Omega$ , L=1mH, L <sub>S</sub> = 150nH, T <sub>J</sub> = 25°C	CT4
E <sub>total</sub>	Total Switching Loss	_	178	229	1	Energy losses include tail and diode reverse recovery	
t <sub>d(on)</sub>	Turn-On delay time	_	27	35		$I_{\rm C} = 6.0$ A, $V_{\rm CC} = 400$ V	
t <sub>r</sub>	Rise time	_	11	15	ns	R <sub>G</sub> = 47Ω, L=1mH, L <sub>S</sub> = 150nH	CT4
t <sub>d(off)</sub>	Turn-Off delay time	_	75	93	1	T <sub>J</sub> = 25°C	
t <sub>f</sub>	Fall time	_	17	22	1		
Eon	Turn-On Switching Loss	_	140	_		I <sub>C</sub> = 6.0A, V <sub>CC</sub> = 400V, V <sub>GE</sub> = 15V	13,15
E <sub>off</sub>	Turn-Off Switching Loss	_	189	_	μJ	R <sub>G</sub> = 47Ω, L=1mH, L <sub>S</sub> = 150nH, T <sub>J</sub> = 175°C	CT4
E <sub>total</sub>	Total Switching Loss	_	329	_	1	Energy losses include tail and diode reverse recovery	WF1,WF2
t <sub>d(on)</sub>	Turn-On delay time	_	26	_		$I_{\rm C} = 6.0$ A, $V_{\rm CC} = 400$ V	14,16
t <sub>r</sub>	Rise time	_	12	_	ns	R <sub>G</sub> = 47Ω, L=1mH, L <sub>S</sub> = 150nH	CT4
t <sub>d(off)</sub>	Turn-Off delay time	_	95	_	1	T <sub>J</sub> = 175°C	WF1,WF2
t <sub>f</sub>	Fall time	_	32	_	1		
C <sub>ies</sub>	Input Capacitance	_	350	_		$V_{GE} = 0V$	23
C <sub>oes</sub>	Output Capacitance	_	29	_	pF	$V_{CC} = 30V$	
C <sub>res</sub>	Reverse Transfer Capacitance	_	10	_	1	f = 1Mhz	
						T <sub>J</sub> = 175°C, I <sub>C</sub> = 24A	4
RBSOA	Reverse Bias Safe Operating Area	FU	LL SQU	IARE		V <sub>CC</sub> = 500V, Vp =600V	CT2
						$R_G = 100\Omega$ , $V_{GE} = +20V$ to 0V	
00004			_			V <sub>CC</sub> = 400V, Vp =600V	22
SCSOA	Short Circuit Safe Operating Area	_	5	_	μs	$R_G = 100\Omega$ , $V_{GE} = +15V$ to 0V	CT3, WF4
Erec	Reverse recovery energy of the diode	_	178	_	μJ	T <sub>J</sub> = 175°C	17,18,19
trr	Diode Reverse recovery time	_	74	_	ns	$V_{CC} = 400V, I_F = 6.0A$	20,21
Irr	Peak Reverse Recovery Current	_	12	_	Α	$V_{GE}$ = 15V, Rg = 47 $\Omega$ , L=1mH, L <sub>S</sub> =150nH	WF3

Notes:

 $\textcircled{0}~V_{CC}$  = 80% (V\_{CES}), V\_{GE} = 15V, L = 1.0mH, R\_G = 47  $\Omega.$ 

 $\ensuremath{\textcircled{O}}$  Pulse width limited by max. junction temperature.

 $\ensuremath{\mathbb{S}}$  R<sub>heta</sub> is measured at T<sub>J</sub> approximately 90°C.

- 3 Refer to AN-1086 for guidelines for measuring V<sub>(BR)CES</sub> safely.
- S When mounted on 1" square PCB (FR-4 or G-10 Material). For recommended footprint and soldering techniques refer to application note #AN-994.

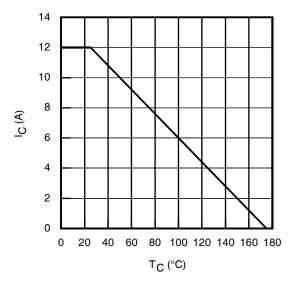
## Qualification Information<sup>†</sup>

		Automotive (per AEC-Q101) <sup>††</sup>				
Qualification Lev						
Moisture Sensitivity Level		D-Pak I-PAK	MSL1			
ESD Machine Model Human Body Model Charged Device Model		Class M2 (+/- 200V) <sup>†††</sup> AEC-Q101-002				
		Class H1A (+/- 500V) <sup>†††</sup> AEC-Q101-001				
		Class C5 (+/- 1000V) <sup>†††</sup> AEC-Q101-005				
<b>RoHS Compliant</b>	•	Yes				

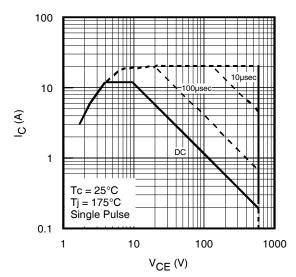
† Qualification standards can be found at International Rectifier's web site: <u>http://www.irf.com</u>

**††** Exceptions to AEC-Q101 requirements are noted in the qualification report.

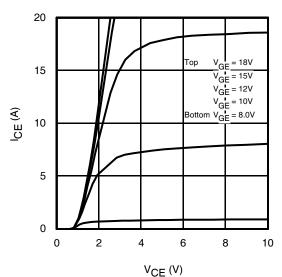
††† Highest passing voltage.

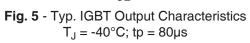












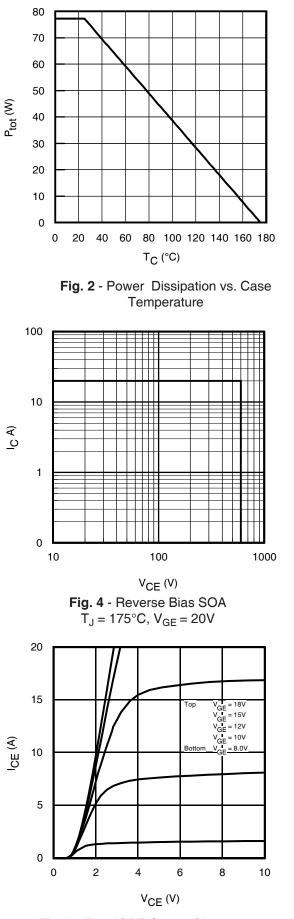
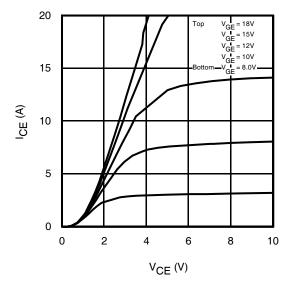
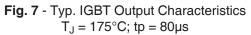
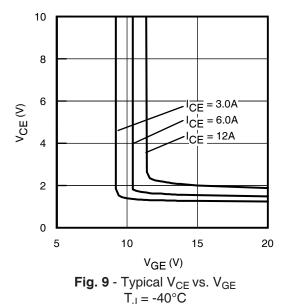


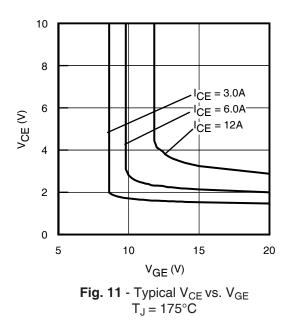
Fig. 6 - Typ. IGBT Output Characteristics  $T_J = 25^{\circ}C$ ; tp = 80µs

# International **TOR** Rectifier











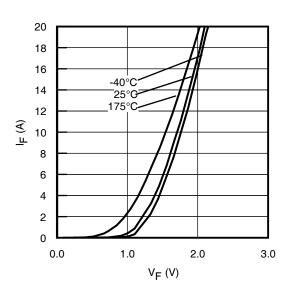


Fig. 8 - Typ. Diode Forward Characteristics  $tp = 80\mu s$ 

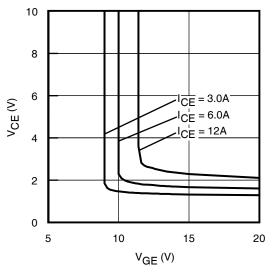
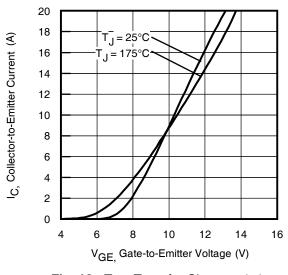
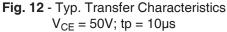
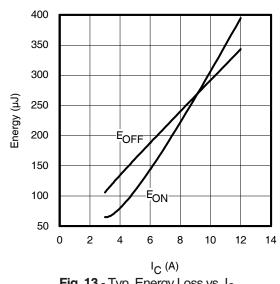


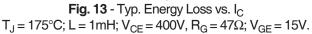
Fig. 10 - Typical V<sub>CE</sub> vs. V<sub>GE</sub>  $T_J = 25^{\circ}C$ 

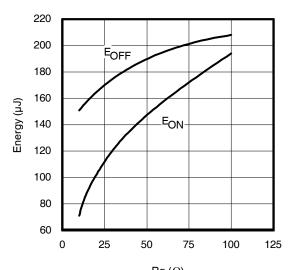




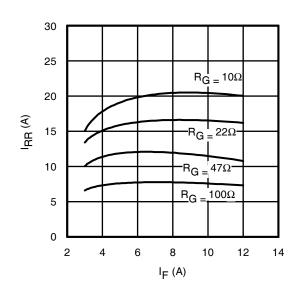
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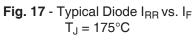


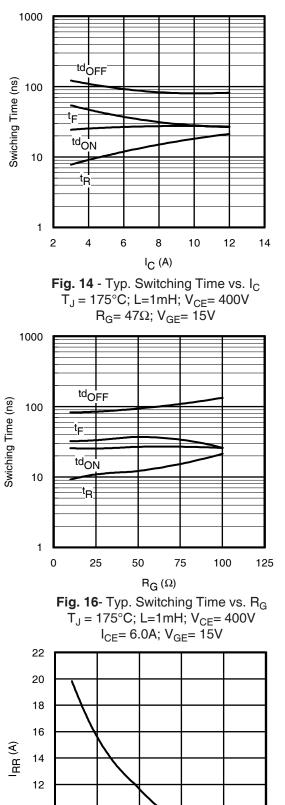


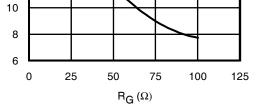


 $\begin{array}{c} \text{Rg}\,(\Omega)\\ \textbf{Fig. 15} \text{ - Typ. Energy Loss } \text{vs. } \text{R}_{\text{G}}\\ \text{T}_{\text{J}} = 175^{\circ}\text{C}; \, \text{L} = 1\text{mH}; \, \text{V}_{\text{CE}} = 400\text{V}, \, \text{I}_{\text{CE}} = 6.0\text{A}; \, \text{V}_{\text{GE}} = 15\text{V} \end{array}$ 





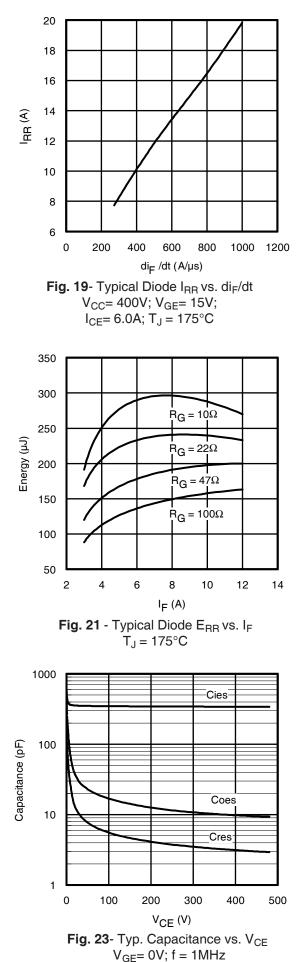


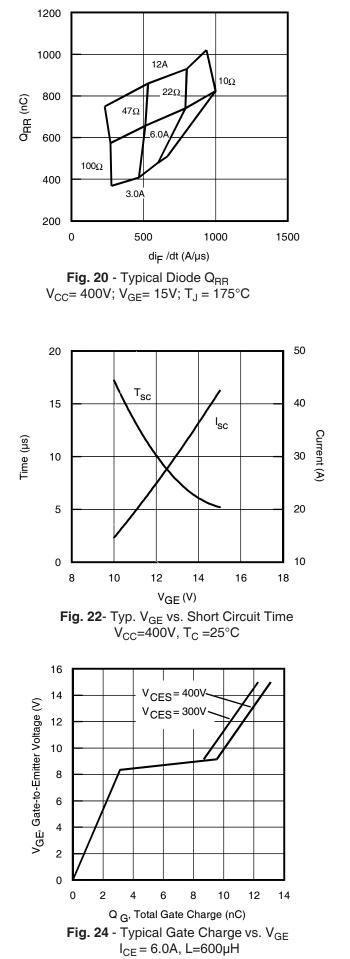




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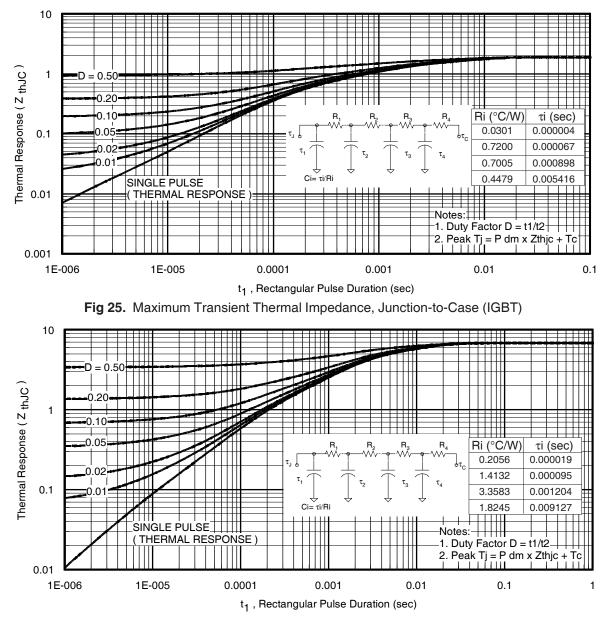


Fig. 26. Maximum Transient Thermal Impedance, Junction-to-Case (DIODE)

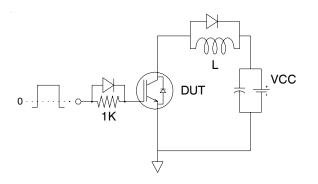


Fig.C.T.1 - Gate Charge Circuit (turn-off)

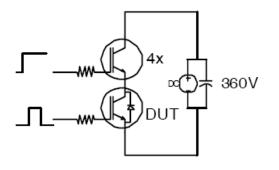


Fig.C.T.3 - S.C.SOA Circuit

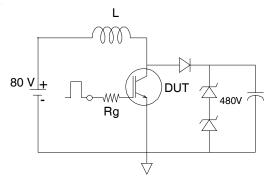


Fig.C.T.2 - RBSOA Circuit

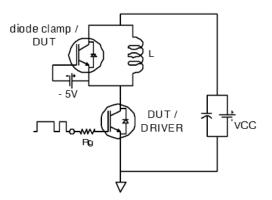
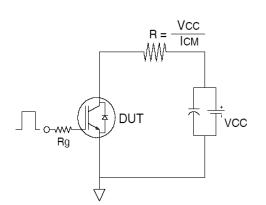
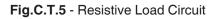
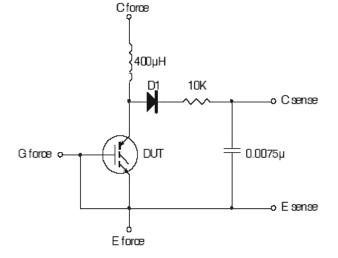


Fig.C.T.4 - Switching Loss Circuit







 $\begin{array}{l} \textbf{Fig.C.T.6} \text{ - Typical Filter Circuit for} \\ \textbf{V}_{(\text{BR})\text{CES}} \text{ Measurement} \end{array}$ 

# International

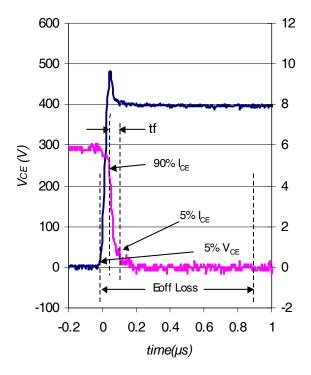
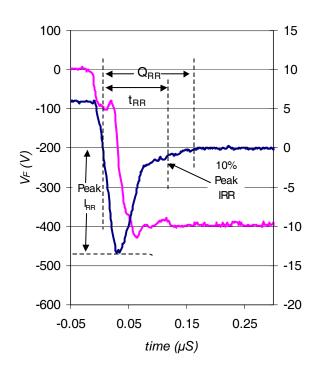


Fig. WF1 - Typ. Turn-off Loss Waveform @  $T_J = 175^{\circ}C$  using Fig. CT.4





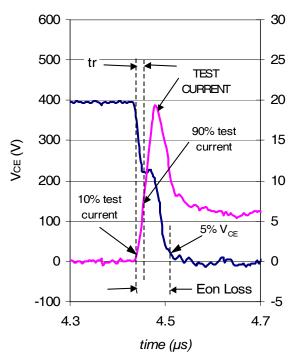
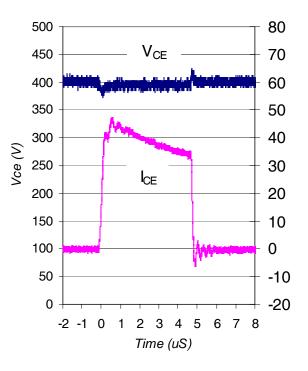


Fig. WF2 - Typ. Turn-on Loss Waveform @  $T_J = 175^{\circ}C$  using Fig. CT.4



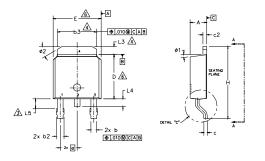


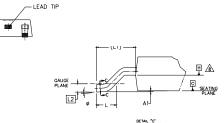
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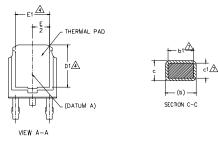
## D-Pak (TO-252AA) Package Outline

Dimensions are shown in millimeters (inches)









- NOTES:
- 1.- DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994
- 2.- DIMENSION ARE SHOWN IN INCHES [MILLIMETERS].
- A- LEAD DIMENSION UNCONTROLLED IN L5.
- A- DIMENSION D1, E1, L3 & b3 ESTABLISH A MINIMUM MOUNTING SURFACE FOR THERMAL PAD.
- 5.- SECTION C-C DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN .005 AND 0.10 [0.13 AND 0.25] FROM THE LEAD TIP.
- DIMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED .005 [0.13] PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY.
   DIMENSION b1 & c1 APPLIED TO BASE METAL ONLY.
- A DATUM A & B TO BE DETERMINED AT DATUM PLANE H.
- DATUM A & B TO BE DETERMINED AT DATUM PLANE
   9.- OUTLINE CONFORMS TO JEDEC OUTLINE TO-252AA.

SY			N O T			
M B O	MILLIMETERS		INC	INCHES		
L	MIN.	MAX.	MIN.	MAX.	Ē	
А	2.18	2.39	.086	.094		
A1	-	0.13	-	.005		
ь	0.64	0.89	.025	.035		
Ь1	0.65	0.79	.025	.031	7	
b2	0,76	1.14	.030	.045		
b3	4.95	5,46	.195	.215	4	
с	0.46	0.61	.018	.024		
c1	0.41	0.56	.016	.022	7	
c2	0,46	0,89	,018	.035		
D	5.97	6.22	.235	.245	6	
D1	5.21	-	.205	-	4	
Ε	6.35	6,73	.250	.265	6	
E1	4.32	-	,170	-	4	
е	2.29	BSC	.090	.090 BSC		
н	9.40	10,41	.370	,410		
L	1,40	1.78	.055	.070		
L1	2.74	BSC	.108	REF.		
L2	0.51	BSC	.020 BSC			
L3	0.89	1.27	.035	.050	4	
L4	-	1.02	-	.040		
L5	1,14	1.52	.045	.060	3	
ø	0.	10*	0*	10*		
ø1	0.	15*	0.	15		
ø2	25'	35'	25*	35"		

#### LEAD ASSIGNMENTS

HEXFET

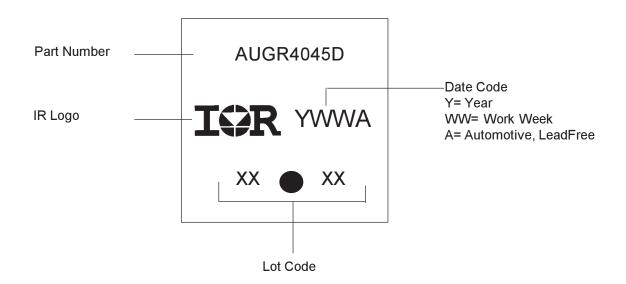
1.- GATE 2.- DRAIN 3.- SOURCE 4.- DRAIN

#### IGBT & CoPAK

1.- GATE 2.- COLLECTOR 3.- EMITTER

3.- EMITTER
 4.- COLLECTOR

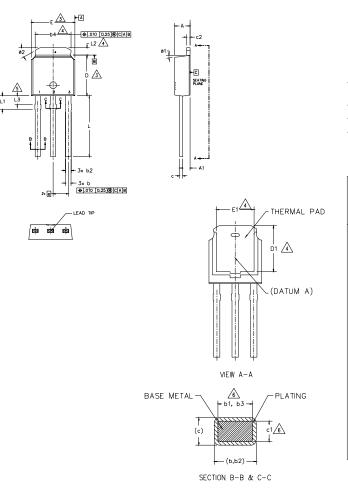
## D-Pak Part Marking Information



Note: For the most current drawing please refer to IR website at http://www.irf.com/package/

## I-Pak (TO-251AA) Package Outline

Dimensions are shown in millimeters (inches)



NOTES:

- 1.- DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994
- 2.- DIMENSION ARE SHOWN IN INCHES [MILLIMETERS].
- dimension d & e do not include Mold Flash. Mold flash shall not exceed .005 [0.13] per side. These dimensions are measured at the outmost extremes of the plastic body.
- A- THERMAL PAD CONTOUR OPTION WITHIN DIMENSION 64, L2, E1 & D1.
- A- LEAD DIMENSION UNCONTROLLED IN L3.
- DIMENSION 61, 63 & c1 APPLY TO BASE METAL ONLY.
- 7.- OUTLINE CONFORMS TO JEDEC OUTLINE TO-251AA (Date 06/02).
- 8.- CONTROLLING DIMENSION : INCHES.

S Y		N O T				
M B	MILLIM	ETERS	INC	INCHES		
0 L	Min.	MAX.	MIN.	MAX.	Ē	
Α	2.18	2.39	.086	.094		
A1	0.89	1.14	.035	.045		
b	0.64	0.89	.025	.035		
b1	0.65	0,79	.025	.031	6	
b2	0.76	1.14	.030	.045		
b3	0.76	1.04	.030	.041	6	
b4	4.95	5.46	.195	.215	4	
с	0.46	0.61	.018	.024		
c1	0.41	0,56	.016	.022	6	
c2	0.46	0.89	.018	.035		
D	5.97	6.22	.235	.245	3	
D1	5.21	-	.205	-	4	
Е	6.35	6.73	.250	.265	3	
E1	4.32	-	.170	-	4	
е	2.29	2.29 BSC		BSC		
L	8,89	9.65	.350	.380		
L1	1.91	2.29	.045	.090		
L2	0.89	1.27	.035	.050	4	
L3	1.14	1.52	.045	.060	5	
ø1	0°	15 <b>'</b>	0.	15°		
Ø2	25	35	25*	35'		
					•	

#### LEAD ASSIGNMENTS

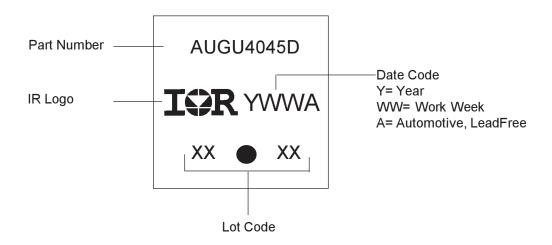
<u>HEXFET</u>

1.- GATE

2.- DRAIN

3.- SOURCE 4.- DRAIN

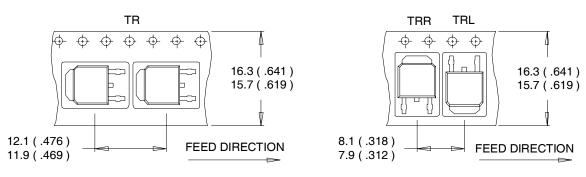
## I-Pak Part Marking Information



Note: For the most current drawing please refer to IR website at http://www.irf.com/package/

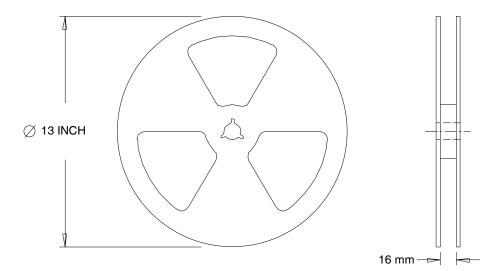
## D-Pak (TO-252AA) Tape & Reel Information

Dimensions are shown in millimeters (inches)



#### NOTES :

- 1. CONTROLLING DIMENSION : MILLIMETER.
- 2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS ( INCHES ).
- 3. OUTLINE CONFORMS TO EIA-481 & EIA-541.



#### NOTES :

1. OUTLINE CONFORMS TO EIA-481.

## **Ordering Information**

Base part number	Package Type	Standard Pack	Complete Part Number	
		Form	Quantity	
AUIRGR4045D	Dpak	Tube	75	AUIRGR4045D
		Tape and Reel	2000	AUIRGR4045DTR
		Tape and Reel Left	3000	AUIRGR4045DTRL
		Tape and Reel Right	3000	AUIRGR4045DTRR
AUIRGU4045D	Ipak	Tube	75	AUIRGU4045D

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